

1410326-3 ✓ ACTIVE

MULTIGIG RT | MULTIGIG RT 2

TE Internal #: 1410326-3

High Speed Backplane Connectors, 112 Position, Mating Alignment, Guide Slot Mating Alignment Type, 7 Row, 16 Column, PCB Mount Header, MULTIGIG RT 2

[View on TE.com >](#)



Connectors > PCB Connectors > Backplane Connectors > High Speed Backplane Connectors



Connector System: **Board-to-Board**

Number of Positions: **112**

Row-to-Row Spacing: **1.35 mm [.053 in]**

Mating Alignment: **With**

Mating Alignment Type: **Guide Slot**

Features

Product Type Features

| | |
|---------------------------------------|-----------------------|
| Backplane Module Type | Center |
| Applied to Printed Circuit Board Type | Daughtercard |
| Connector System | Board-to-Board |
| PCB Connector Assembly Type | PCB Mount Header |
| Shroud Style | Fully Shrouded |
| Connector & Contact Terminates To | Printed Circuit Board |

Configuration Features

| | |
|----------------------------|-----------------------|
| Number of Ground Positions | 31 |
| Card Slot Centerline | 20.3 mm[.8 in] |
| Number of Pairs | 20 |
| Backplane Architecture | Traditional Backplane |
| Number of Positions | 112 |
| Number of Rows | 7 |
| Number of Columns | 16 |
| PCB Mount Orientation | Right Angle |
| Guide Location | Right |

Electrical Characteristics



| | |
|-----------|--------------|
| Impedance | 100 Ω |
|-----------|--------------|

| | |
|-------------------|--------|
| Operating Voltage | 50 VAC |
|-------------------|--------|

Signal Characteristics

| | |
|------------------------|--------------|
| Differential Impedance | 100 Ω |
|------------------------|--------------|

| | |
|---|---|
| Number of Differential Pairs per Column | 2 |
|---|---|

| | |
|-----------|----------------|
| Data Rate | ≤ 12 Gb/s |
|-----------|----------------|

Body Features

| | |
|-----------------------|-------|
| Primary Product Color | Black |
|-----------------------|-------|

Contact Features

| | |
|----------------------------|---------------|
| Contact Mating Area Length | 2.9 mm[.8 in] |
|----------------------------|---------------|

| | |
|---|---|
| PCB Contact Termination Area Plating Material Thickness | 1.27 μm [50 μin] |
|---|---|

| | |
|----------------|--------|
| Contact Layout | Inline |
|----------------|--------|

| | |
|--------------|-----|
| Contact Type | Pin |
|--------------|-----|

| | |
|---|---|
| Contact Underplating Material Thickness | 1.27 μm [50 μin] |
|---|---|

| | |
|--|---|
| Contact Mating Area Plating Material Thickness | 1.27 μm [50 μin] |
|--|---|

| | |
|--------------------------------------|------|
| Contact Mating Area Plating Material | Gold |
|--------------------------------------|------|

| | |
|--|--------|
| PCB Contact Termination Area Plating Material Finish | Bright |
|--|--------|

| | |
|-------------------------------|--------|
| Contact Underplating Material | Nickel |
|-------------------------------|--------|

| | |
|---|----------|
| PCB Contact Termination Area Plating Material | Tin-Lead |
|---|----------|

| | |
|-----------------------|--------|
| Contact Base Material | Copper |
|-----------------------|--------|

| | |
|------------------------------|-----|
| Contact Current Rating (Max) | 1 A |
|------------------------------|-----|

Termination Features

| | |
|--------------------------------|-----------------|
| Termination Post & Tail Length | 1.4 mm[.055 in] |
|--------------------------------|-----------------|

| | |
|---|--------------------------|
| Termination Method to Printed Circuit Board | Through Hole - Press-Fit |
|---|--------------------------|

Mechanical Attachment

| | |
|----------------|------|
| Guide Hardware | With |
|----------------|------|

| | |
|------------------|------|
| Mating Retention | With |
|------------------|------|

| | |
|---------------------|------|
| PCB Mount Alignment | With |
|---------------------|------|

| | |
|---------------------|------|
| PCB Mount Retention | With |
|---------------------|------|

| | |
|--------------------------|-----------------------|
| PCB Mount Retention Type | Action/Compliant Tail |
|--------------------------|-----------------------|

| | |
|------------------|------|
| Mating Alignment | With |
|------------------|------|

| | |
|-----------------------|------------|
| Mating Alignment Type | Guide Slot |
|-----------------------|------------|



Connector Mounting Type

Board Mount

Housing Features

Number of Shrouded Sides

2

Housing Material

LCP (Liquid Crystal Polymer)

Centerline (Pitch)

1.8 mm[.07 in]

Dimensions

Connector Length

28.68 mm[1.129 in]

Connector Height

18.4 mm[.724 in]

PCB Thickness (Recommended)

1.6 – 4 mm[.062 – .157 in]

PCB Hole Diameter

.46 mm[.018 in]

Row-to-Row Spacing

1.35 mm[.053 in]

Usage Conditions

Operating Temperature Range

-55 – 105 °C[-67 – 221 °F]

Operation/Application

Durability Rating

500 Cycles

Circuit Application

Power & Signal

Packaging Features

Packaging Method

Tube

Product Compliance

For compliance documentation, visit the product page on [TE.com](#)>

EU RoHS Directive 2011/65/EU

Not Compliant

EU ELV Directive 2000/53/EC

Compliant with Exemptions

China RoHS 2 Directive MIIT Order No 32, 2016

Restricted Materials Above Threshold

EU REACH Regulation (EC) No. 1907/2006

Current ECHA Candidate List: JUNE 2023
(235)
Candidate List Declared Against: JAN 2021
(211)
SVHC > Threshold:
Pb (7% in contact plating)
Article Safe Usage Statements:
Do not eat, drink or smoke when using this product. Wash thoroughly after handling. Recycle if possible and dispose of the article by following all applicable governmental regulations relevant to your geographic location.

Halogen Content

BFR/CFR/PVC Free, but Br/Cl >900 ppm in other sources.

Solder Process Capability

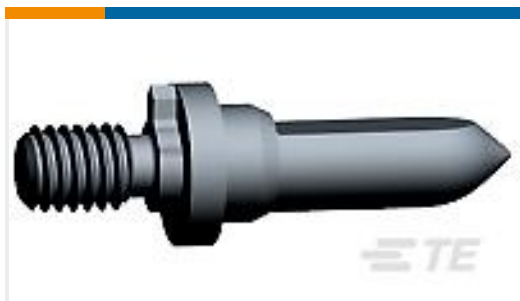
Not applicable for solder process capability



Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: <https://echa.europa.eu/guidance-documents/guidance-on-reach>

Compatible Parts

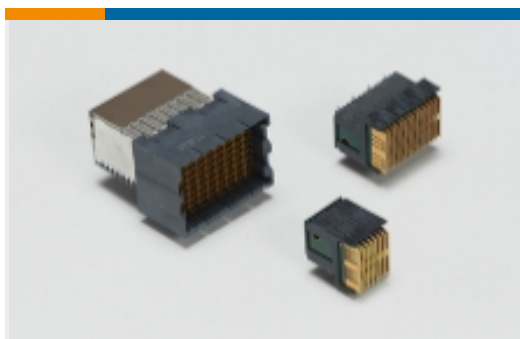


TE Part # 2000676-1
Keyed Guide Pin, Machined, Vita 46



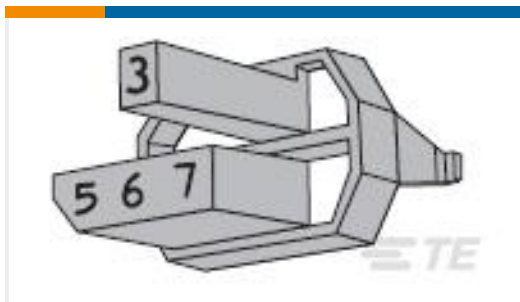
TE Part # 2000713-1
RA Keyed Guide Mod, Vita 46, Machined

Also in the Series | MULTIGIG RT 2



High Speed Backplane Connectors(42)

Customers Also Bought



TE Part #2-100526-0
Z-PACK F.CODING KEY



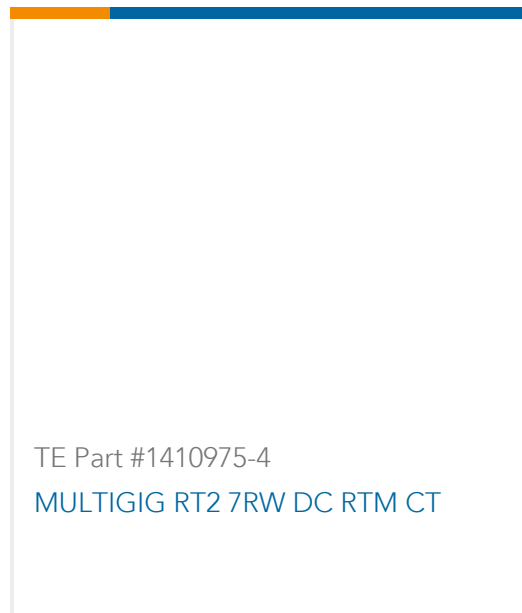
TE Part #6339167-2
ASSY,SHLD,1X4,MJ,WAVE PNL



TE Part #6339169-3
ASSY,SHLD,1X8,MJ,WAVE PNL



TE Part #2309407-2
DDR4 SODIMM 260P 4.0H STD



Documents

Product Drawings

MULTIGIG RT T2 7RW DC DF CT

English

CAD Files

3D PDF

3D

Customer View Model

[ENG_CVM_CVM_1410326-3_B.2d_dxf.zip](#)

English

Customer View Model

[ENG_CVM_CVM_1410326-3_B.3d_igs.zip](#)

English

Customer View Model

[ENG_CVM_CVM_1410326-3_B.3d_stp.zip](#)

English

By downloading the CAD file I accept and agree to the [Terms and Conditions](#) of use.

Datasheets & Catalog Pages

SOSA Aligned Interconnect Solutions

English